Revision. 5

Zener Diode

DE2703600L

# **Panasonic**

# DE2703600L

### Silicon epitaxial planar type

For ESD protection DE2S036 in SSSMini2 type package

#### ■ Features

- High ESD
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol:6C

### ■ Packaging

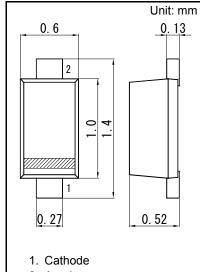
Embossed type (Thermo-compression sealing) 10 000 pcs / reel (standard)

#### ■ Absolute Maximum Ratings Ta = 25 °C Parameter Symbol Rating Unit Total power dissipation mWPT 120 Electrostatic discharge **ESD** ±30 kV Junction temperature Τį 150 °C

Operating ambient temperature Topr -40 to +85 °C Storage temperature -55 to +150 °C Tstg

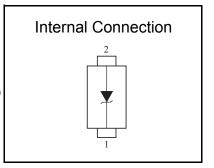
Note) \*1: Mounted on glass epoxy print board. ( 45 mm x 45 mm x 1 mm) Solder in (0.4 mm x 0.3 mm)

\*2: Test method:IEC61000\_4\_2(C = 150 pF,R = 330  $\Omega$ , Contact discharge:10 times)



2. Anode

Panasonic	SSSMini2-F4-B
JEITA	SC-104A
Code	SOD-723



#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Zener voltage *1,*2	VZ	IZ = 1 mA	3.42		3.78	V
Reverse current	IR	VR = 1 V			10.0	μA
Terminal capacitance	Ct	VR = 0V, f = 1 MHz		97		pF
Temperature coefficient of zener voltage *3	SZ	IZ = 1 mA		-2.3		mV/°C

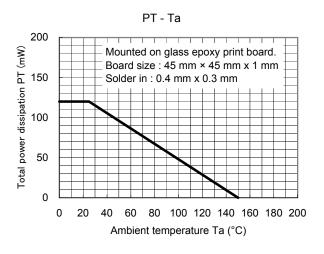
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. \*1: The temperature must be controlled 25°C for VZ mesurement. VZ value measured at other temperature must be adjusted to VZ (25°C)
    - \*2: VZ guaranted 20 ms after current flow.
    - \*3: Tj = 25°C to 150°C

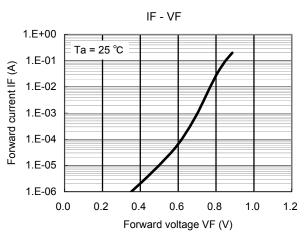
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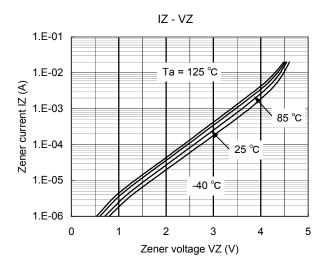
Zener Diode

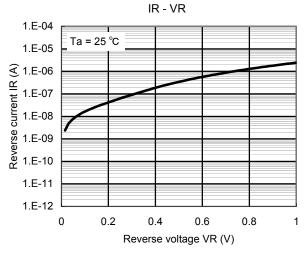
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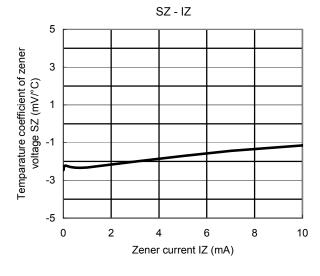
# Technical Data (reference)

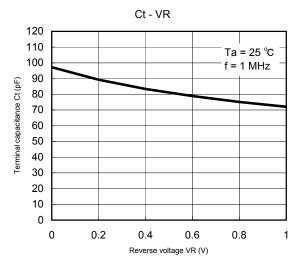












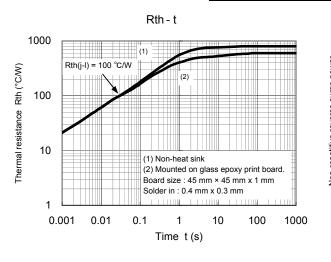
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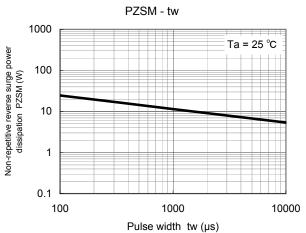
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# Technical Data (reference)





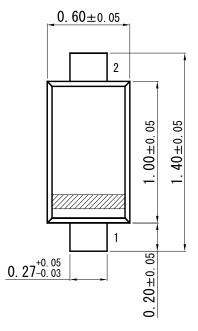
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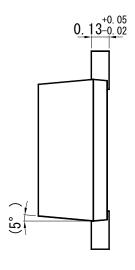
Zener Diode

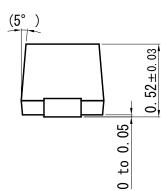
DE2703600L

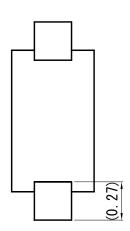
# SSSMini2-F4-B

Unit: mm

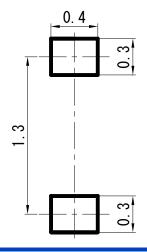








### ■ Land Pattern (Reference) (Unit: mm)



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